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Process Capability, Quality, and Relative Reliability (PCQR²) Benchmark Test Standard and Database

Supersedes IPC-9151C
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A standard developed by IPC

Association Connecting Electronics Industries



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- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

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- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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Printed Board Process Capability, Quality, and Relative Reliability (PCQR²) Benchmark Test Standard and Database

Developed by the PCQR² Subcommittee (D-36) of the Rigid Printed Board Committee (D-30) of IPC

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Users of this publication are encouraged to participate in the development of future revisions.

Contact:

IPC
3000 Lakeside Drive, Suite 309S
Bannockburn, Illinois
60015-1249
Tel 847 615.7100
Fax 847 615.7105



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